

View Online at <https://aerobasegroup.com/nsn/5825-00-598-3745>

**General Description:**

Athis module shall be an encapsulated assembly, weight shall not exceed 3 ounces, parts and material shall be selected in following order of precedence; resistors, carbon shall be selected per mil-r-39008, resistors; metal film per mil-r-10509, resistors; wirewound per mil-r-93, diodes and transistors per mil-s-19500, microelectronic circuits per device families previously used in military applications, 2.170 in. O/a lg, 0.535 in. O/a w, 0.860 in. O/a h, pins shall be brass per qq-b-626, composition 22, pin plating shall be electro-solder per mil-f-14072, m222, environmental conditions module shall meet after encapsulation are shock per mil-std-202, method 213, test condition j, vibration per mil-std-202, method 201

**Shelf Life:**

N/a

**Unit Of Measure:**

--

**Demilitarization:**

Yes - demil/mli